



Preliminary Exhibitor list A to Z (as of June 10, 2026)

- **Advanced Electronic Materials Inc.** (TW)
- **Beneli AB** (SE)
- **Blackleaf** (FR)
- **BST GmbH** (DE)
- **Conductive Technologies Inc.** (US)
- **Covestro Deutschland AG** (DE)
- **DICO Electronic GmbH** (DE)
- **DoMicro BV** (NL)
- **E Ink Corporation** (US)
- **Ebiologic Technology Co., Ltd.** (TW)
- **Epishine AB** (SE)
- **ESMA vzw** (BE)
- **Foehrenbach Application Tooling NV** (BE)
- **Fraunhofer-Institut IAP** (DE)
- **Fraunhofer-Institut IFAM** (DE)
- **GM Grafisk Maskinfabrik A/S** (DK)
- **Grünig SignTronic AG** (CH)
- **Hamamatsu Photonics Deutschland GmbH** (DE)
- **Heraeus Equrio GmbH** (DE)

- **Heraeus Printed Electronics GmbH (DE)**
- **INO d.o.o. (SI)**
- **KETMarket GmbH (DE)**
- **LPKF Laser & Electronics SE (DE)**
- **MicroCraft K.K. (JP)**
- **MSWtech (DE)**
- **nsm Norbert Schläfli AG (CH)**
- **Nagase ChemteX America, LLC (US)**
- **National University Corporation, Yamagata University (JP)**
- **NXT GmbH (DE)**
- **OE-A - Advancing the flexible and printed electronics industry (DE)**
- **PVF Mesh and Screen Technology GmbH (DE)**
- **RK-Siebdrucktechnik GmbH (DE)**
- **SAT Electronic Vertriebs GmbH (DE)**
- **SEFAR AG (CH)**
- **ShenZhen Hochuen Technologies Co., Ltd. (CN)**
- **SPGPrints b.v. (NL)**
- **SPS TechnoScreen GmbH (DE)**
- **Sun Chemical Ltd. (GB)**

- **Teca-Print AG** (CH)
- **TNO** (NL)
- **VFP INK Technologies** (FR)
- **VTT Technical Research Centre of Finland** (FI)
- **Witte Technology GmbH** (DE)
- **XTPL S.A.** (PL)